Revisions

Rev. 0.0 : Development version

Rev. A.0 : Initial Release
- Change L1 to DR74-2R2-R
- Change U3 to W25Q16DWSSIG (SOIC8 208mil)

Rev. B.0 : minor BOM change
- Do not install TPGND3
X1 and passives should be placed very close to the DPP pins.
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